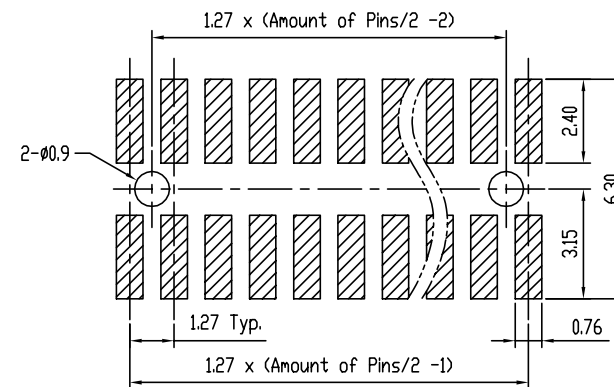
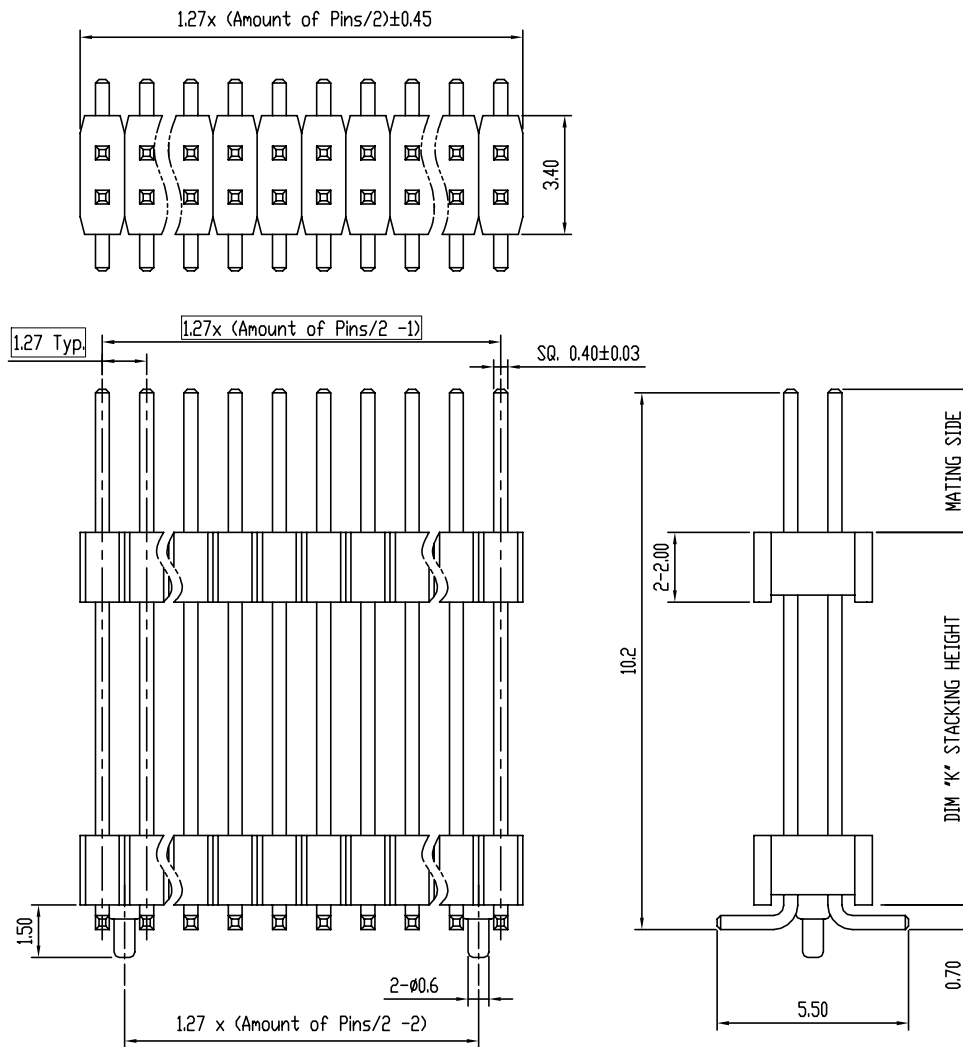


NOTE:

1. MATERIAL:
HOUSING: NYLON 6T (E630NK), UL94V-0
TERMINAL: C2700 H
2. FINISH:
TERMINAL: GOLD AT CONTACT,
G/F OVER 1um(40u") MIN Ni OVER ALL
3. SPEC.:
PRODUCT SPEC: GS-12-629
PACKING SPEC: GS-14-1517
4. THE HSG. WILL WITHSTAND EXPOSURE TO 260C
PEAK TEMP. FOR 10 SEC. IN A CONVECTION, INFRA-RED
OR VAPOR PHASE REFLOW OVEN.
5. MATING SIDE LENGTH: 2.50MM MIN.
6. PRODUCT NUMBERING:
200218 3 2 - XXX XX X X LF

LEAD FREE
PLATING:
1: G/F ALL OVER
4: 0.25um(10U") GOLD AT CONTACT
8: 0.76um(30U") GOLD AT CONTACT
PACKING
T: TUBE
D: TUBE + CAP
C: REEL + CAP (16 PIN)
PIN COUNT
04, 06, 08, ..., 48, 50
(EVERY EVEN PIN)
STACK HEIGHT "K"
EXAMPLE: 045=4.5MM
IN 0.5MM INCREMENT



Recommended P.C.B. Layout
Layout Tolerance = ± 0.05 mm

mat'l. code			surface	tolerance	projection	product family		
			ISO1302	ISO1101 ISO406		MINITEK		
l	tr	ec	n	o	d	r	date	title
A	T10-0088	S	L	I	N	07/15/10		1.27X1.27MM BTB STACK HD
B	BX-W-011534	Z	K	05/04/12				VT, SMT
			angle	0°±2'	0°±2'	scale	5:1	
			dr	STERLING LIN	07/15/10	dwg no		
			eng	STERLING LIN	07/15/10	sheet 1 of 1		
			chr	STERLING LIN	07/15/10	20021832		
			app	GARY HSIEH	07/15/10	A4		
sheet			revision	B		type		
index			sheet	1		Product Customer Drawing		

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

[FCI / Amphenol:](#)

[20021832-04518T1LF](#)